

# SHINDENGEN

## HVX-2 Series Power MOSFET

N-Channel Enhancement type

**2SK2675  
(FP7W90HVX2)**

**900V 7A**

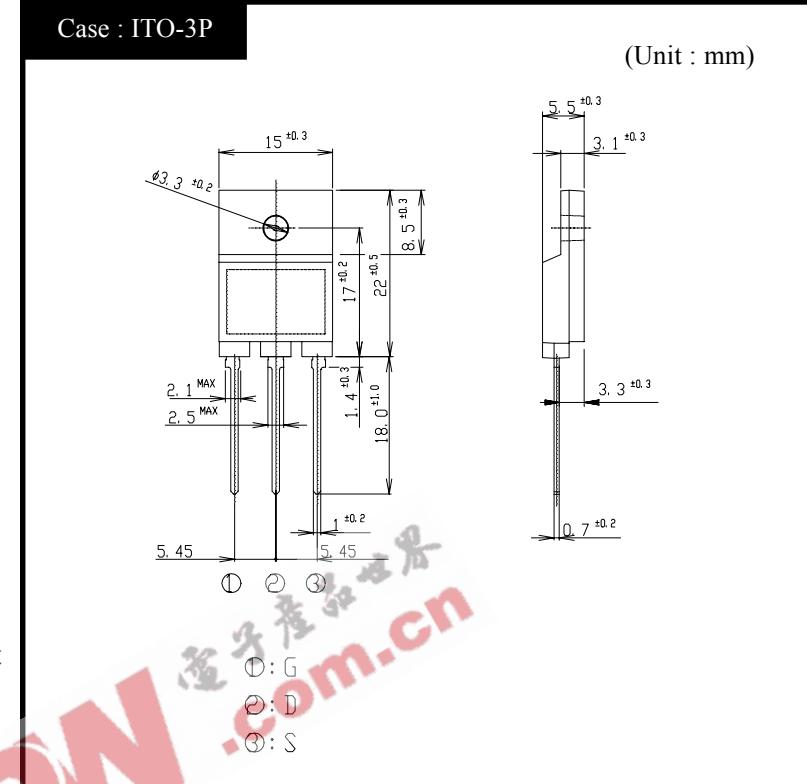
### FEATURES

- Input capacitance ( $C_{iss}$ ) is small.  
Especially, input capacitance at 0 bias is small.
- The static  $R_{ds(on)}$  is small.
- The switching time is fast.
- Avalanche resistance guaranteed.

### APPLICATION

- Switching power supply of AC 240V input
- High voltage power supply
- Inverter

### OUTLINE DIMENSIONS



### RATINGS

#### ● Absolute Maximum Ratings ( $T_c = 25^\circ\text{C}$ )

Item	Symbol	Conditions	Ratings	Unit
Storage Temperature	$T_{stg}$		-55~150	°C
Channel Temperature	$T_{ch}$		150	
Drain-Source Voltage	$V_{DSS}$		900	V
Gate-Source Voltage	$V_{GSS}$		±30	
Continuous Drain Current (DC)	$I_D$		7	A
Continuous Drain Current (Peak)	$I_{DP}$	Pulse width $\leq 10 \mu\text{s}$ , Duty cycle $\leq 1/100$	14	
Continuous Source Current (DC)	$I_S$		7	
Total Power Dissipation	$P_T$		55	W
Repetitive Avalanche Current	$I_{AR}$	$T_{ch} = 150^\circ\text{C}$	7	A
Single Avalanche Energy	$E_{AS}$	$T_{ch} = 25^\circ\text{C}$	160	mJ
Repetitive Avalanche Energy	$E_{AR}$	$T_{ch} = 25^\circ\text{C}$	16	
Dielectric Strength	$V_{dis}$	Terminals to case, AC 1 minute	2	kV
Mounting Torque	$T_{OR}$	( Recommended torque : 0.5 N·m )	0.8	N·m

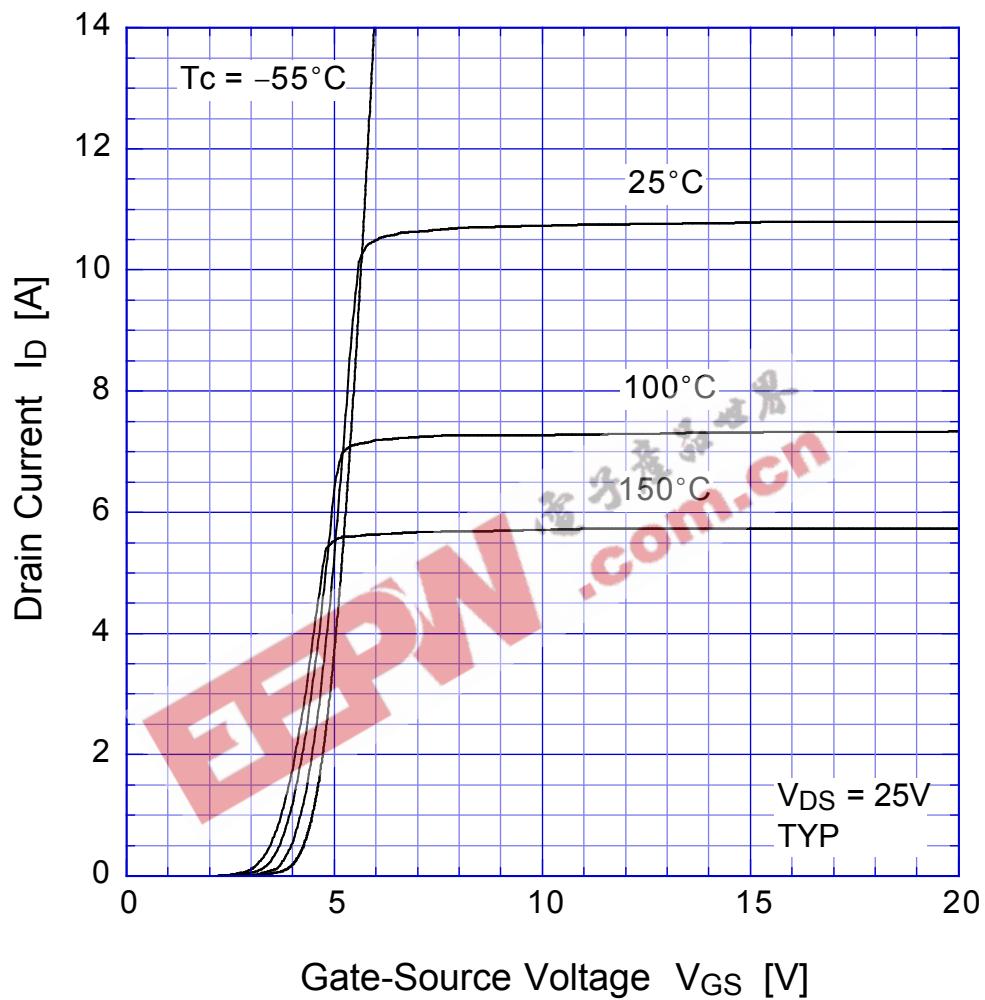
●Electrical Characteristics T<sub>c</sub> = 25°C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	ID = 1mA, VGS = 0V	900			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	VDS = 900V, VGS = 0V			250	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	VGS = ±30V, VDS = 0V			±0.1	
Forward Transconductance	g <sub>fS</sub>	ID = 3.5A, VDS = 10V	3.6	6.0		S
Static Drain-Source On-state Resistance	R <sub>D(S)ON</sub>	ID = 3.5A, VGS = 10V		1.5	2.0	Ω
Gate Threshold Voltage	V <sub>TH</sub>	ID = 1mA, VDS = 10V	2.5	3.0	3.5	V
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	IS = 3.5A, VGS = 0V			1.5	
Thermal Resistance	θ <sub>jc</sub>	junction to case			2.27	°C/W
Total Gate Charge	Q <sub>g</sub>	VDD = 400V, VGS = 10V, ID = 7A		63		nC
Input Capacitance	C <sub>iss</sub>	VDS = 25V, VGS = 0V, f = 1MHz		1450		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			37		
Output Capacitance	C <sub>oss</sub>			150		
Turn-On Time	t <sub>on</sub>	ID = 3.5A, RL = 43Ω, VGS = 10V		95	170	ns
Turn-Off Time	t <sub>off</sub>			330	560	

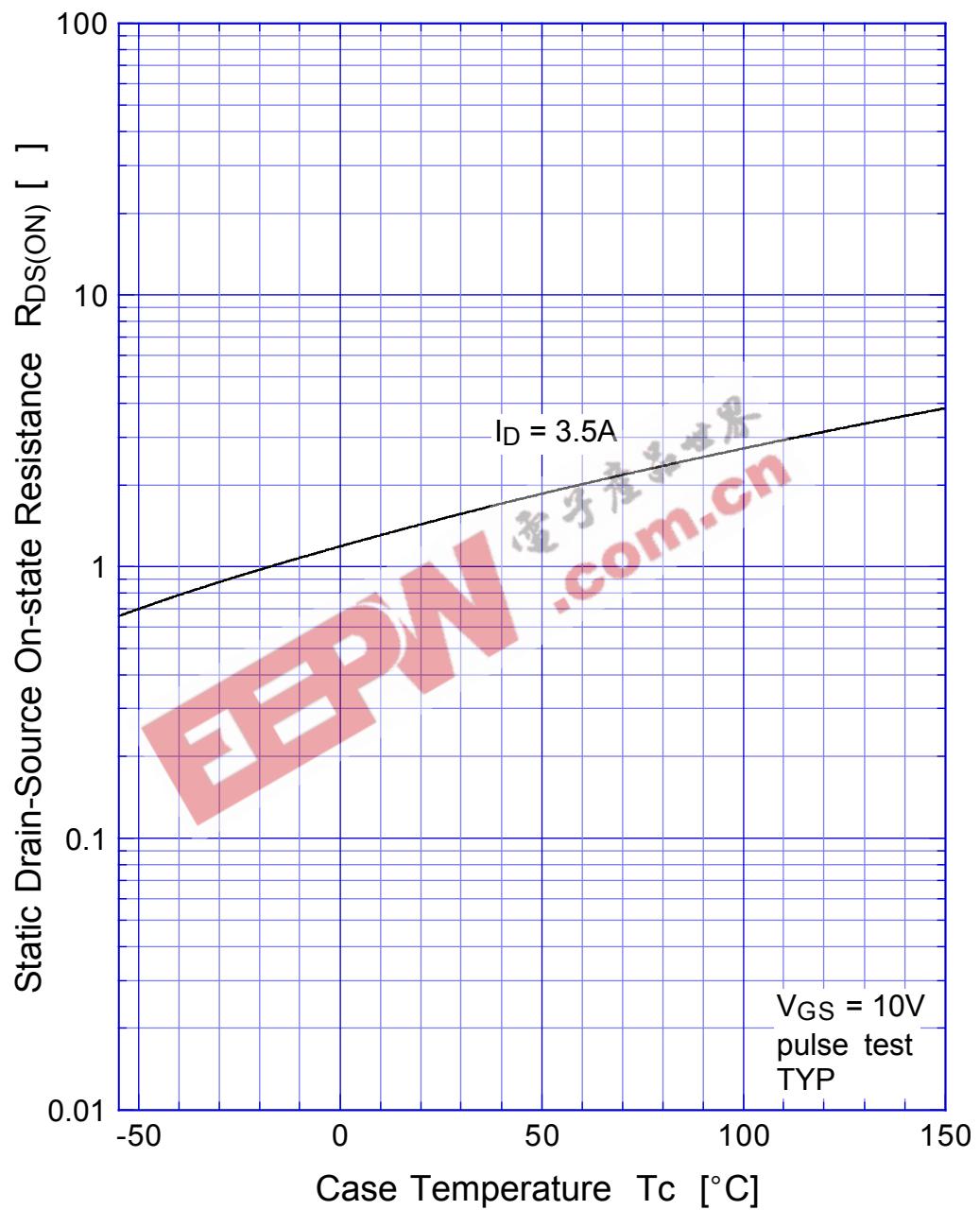
EEBN 爱好者论坛  
www.eebn.com.cn

# 2SK2675

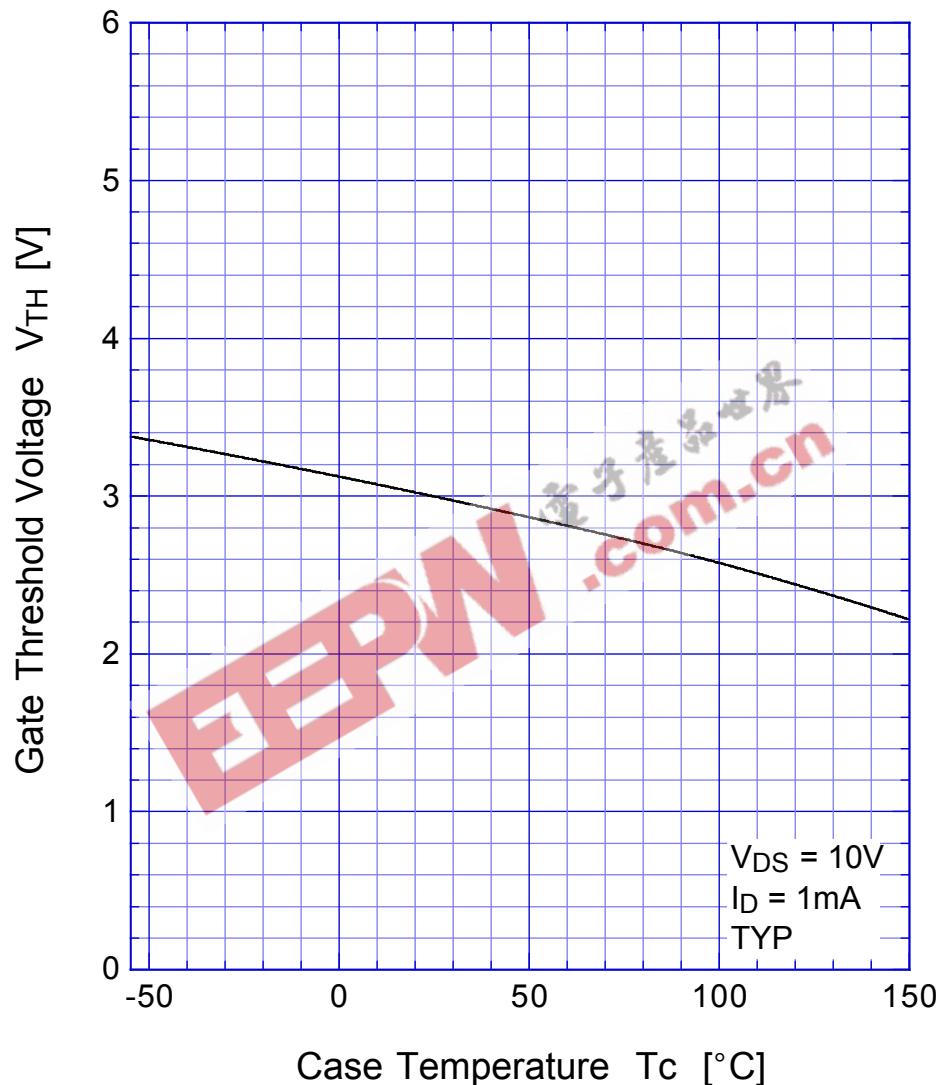
## Transfer Characteristics



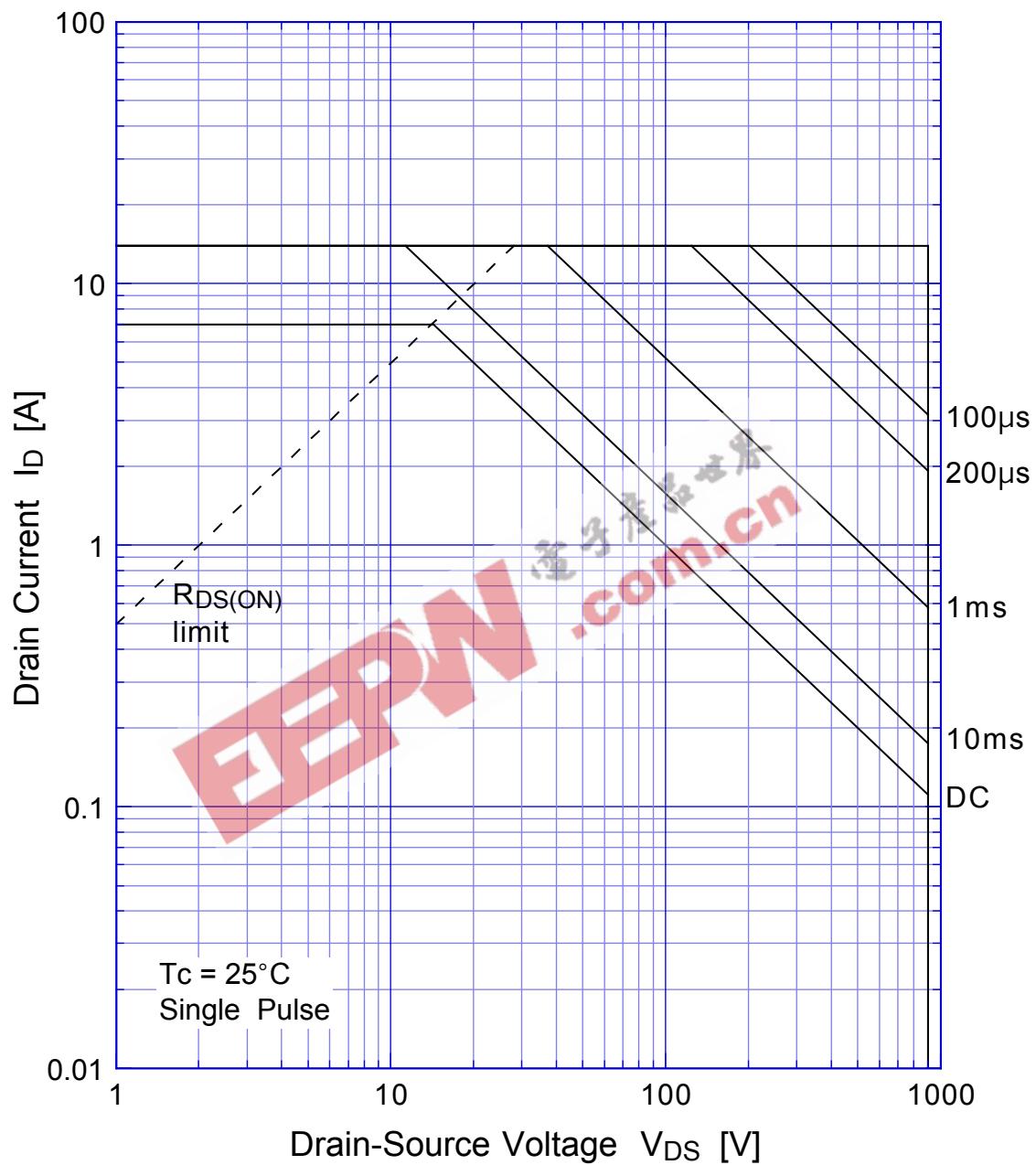
## 2SK2675 Static Drain-Source On-state Resistance



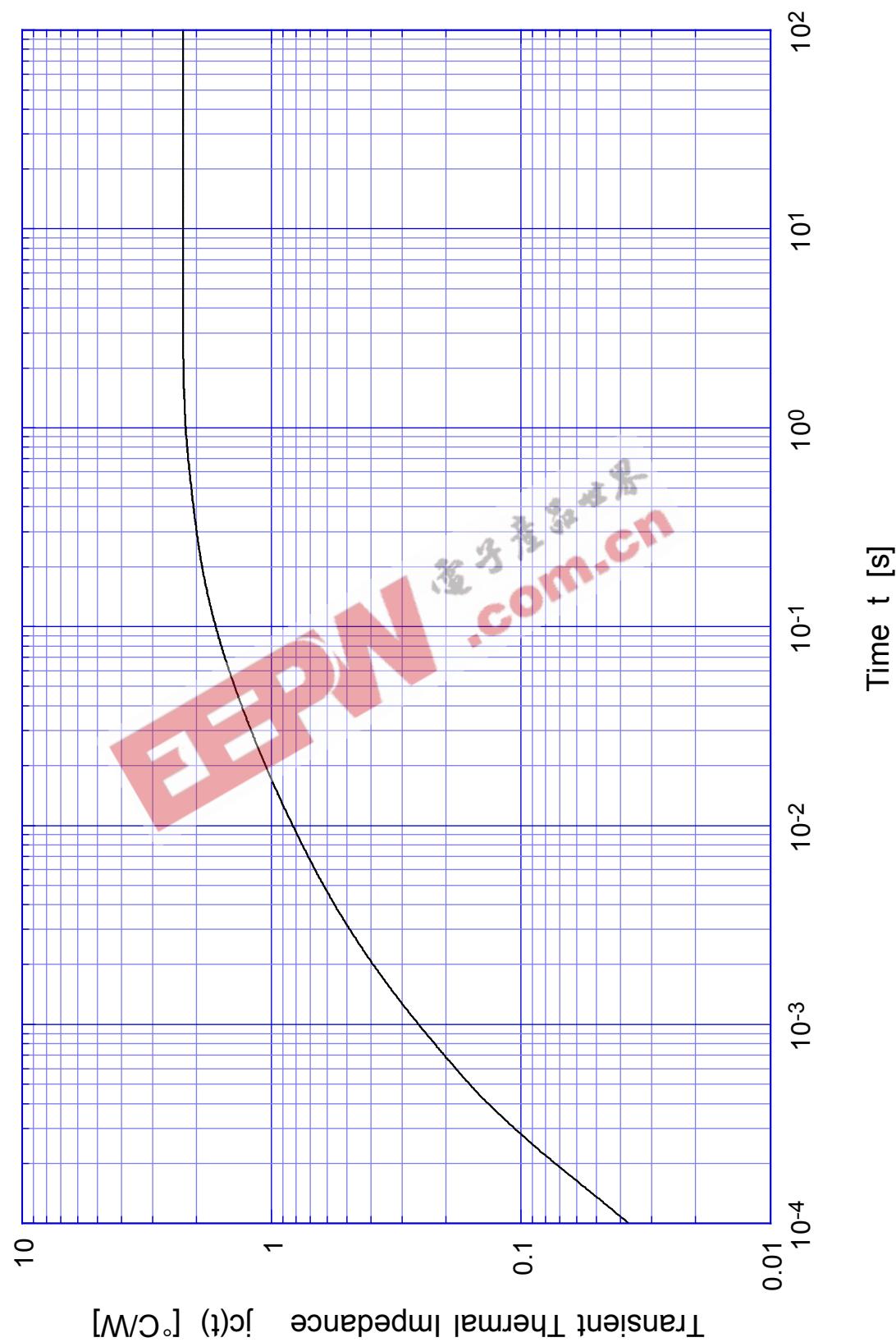
## 2SK2675 Gate Threshold Voltage



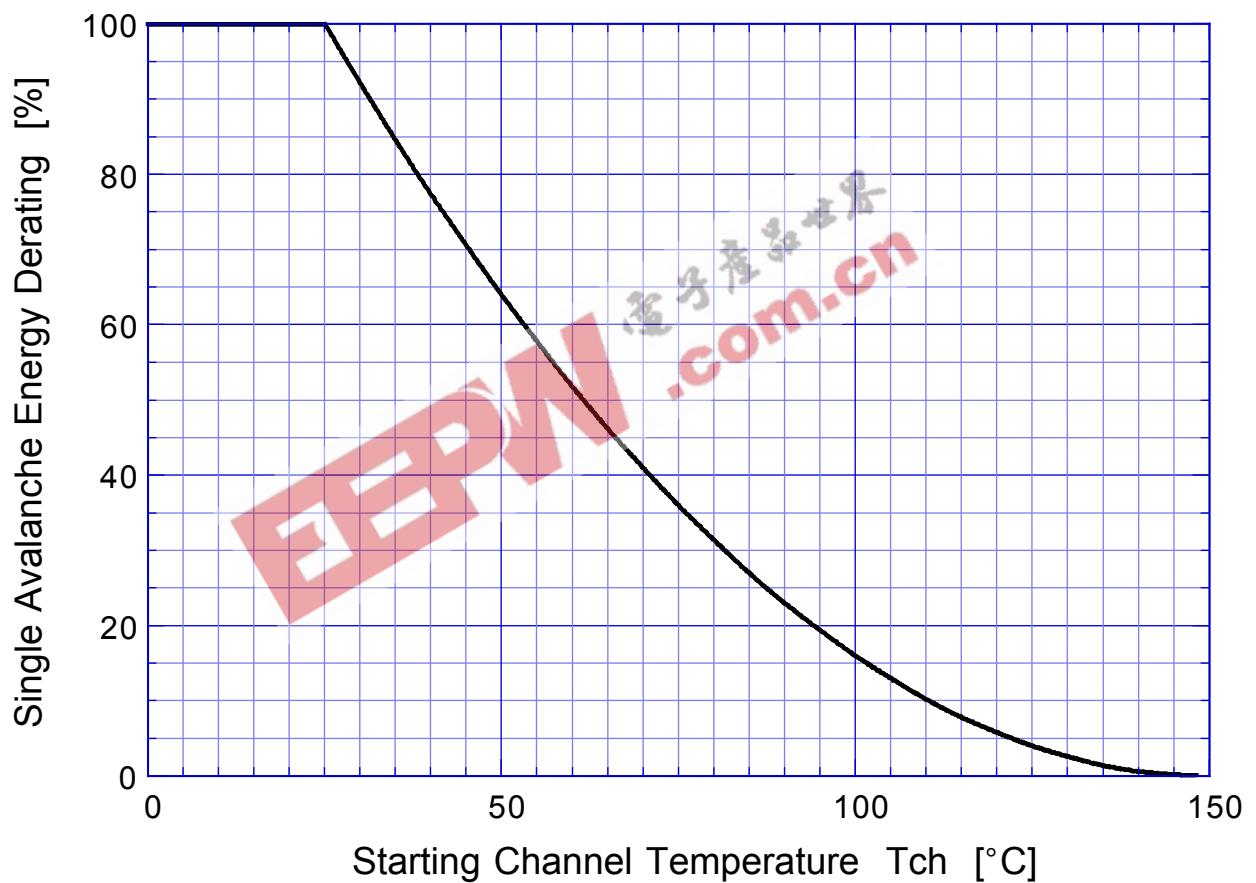
## 2SK2675 Safe Operating Area



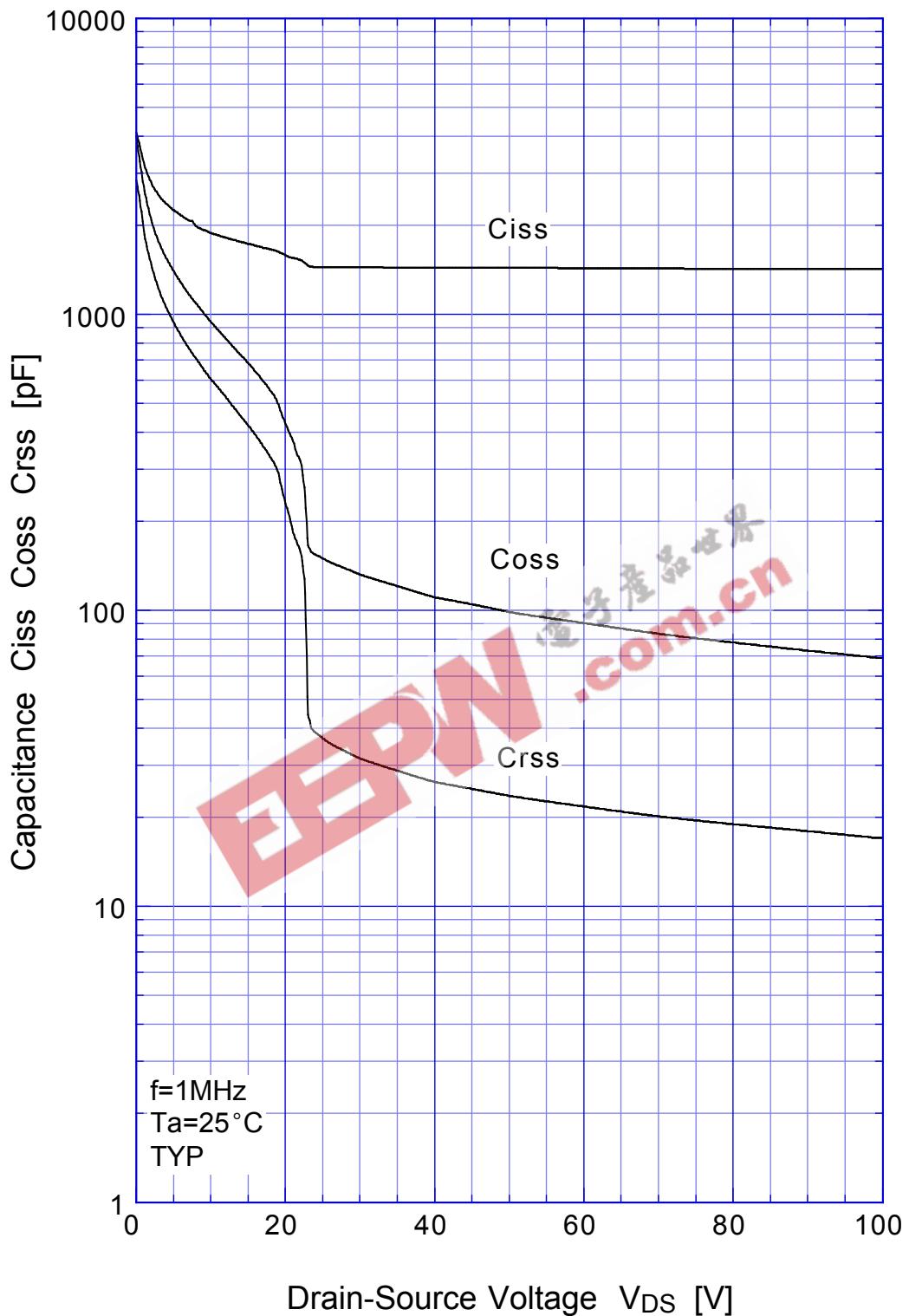
## 2SK2675 Transient Thermal Impedance



## 2SK2675 Single Avalanche Energy Derating

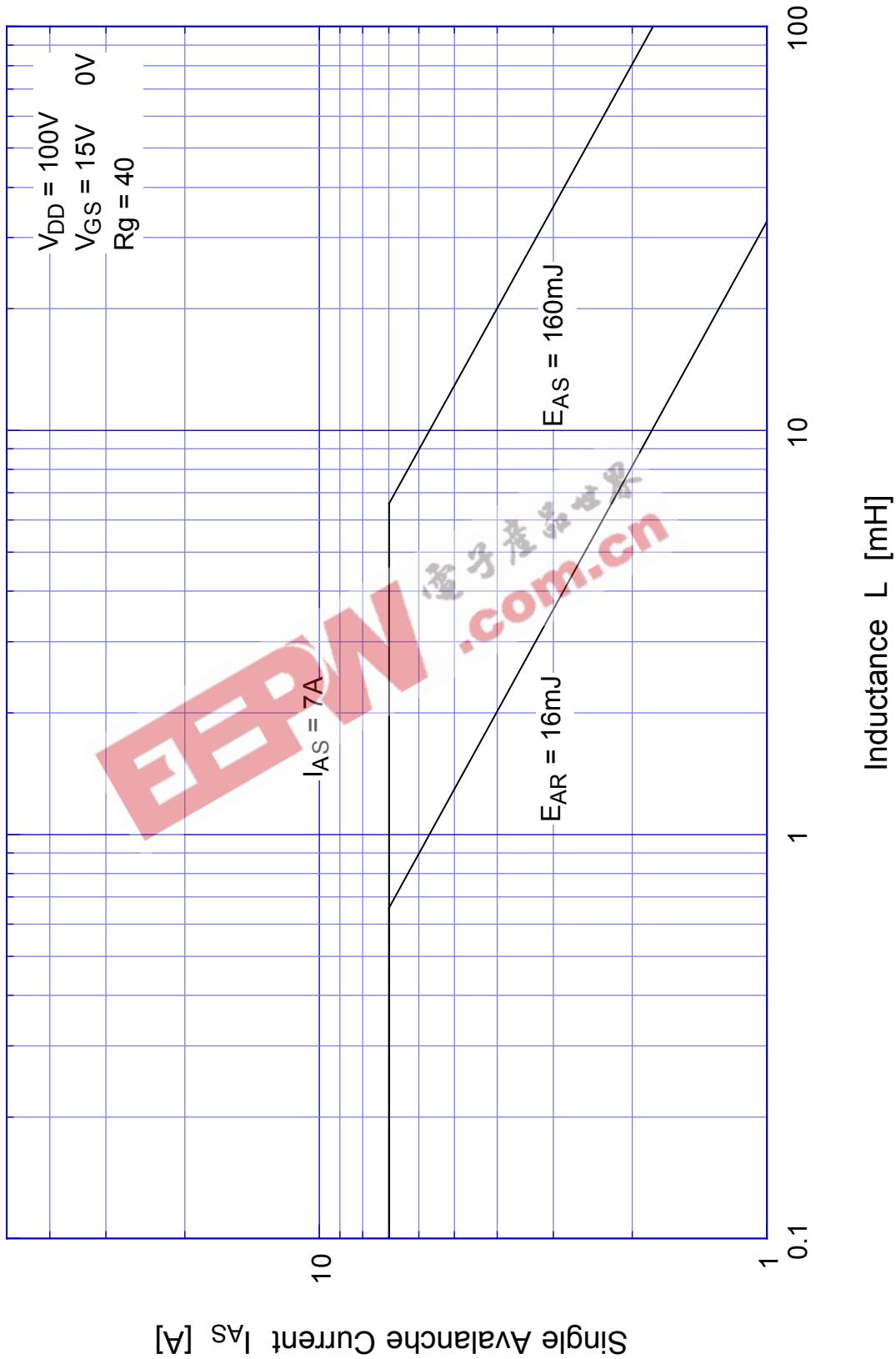


# 2SK2675 Capacitance



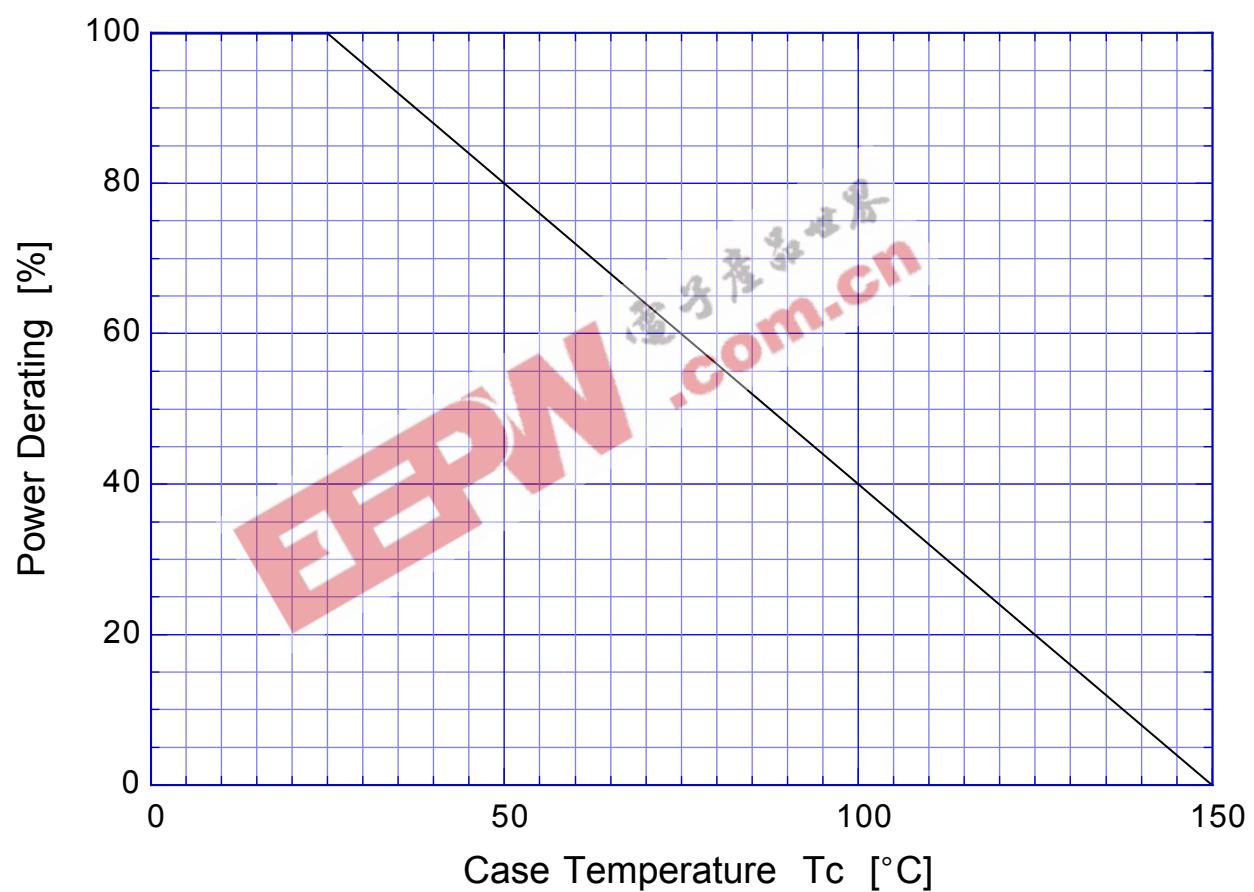
## 2SK2675 Single Avalanche Current - Inductive Load

---



**2SK2675**

Power Derating



# 2SK2675

## Gate Charge Characteristics

